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U.S.S.N. 10/731,983

## DEC 2 2 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Huang et al.

Group Art Unit: 2891

Serial No.: 10/731,983

Examiner: D.A. Zarneke

Filed: 12/10/2003

In Response to Office Action

Dated: 09/22/2005

For: STRUCTURE AND METHOD FOR REINFORCING A BOND PAD ON A CHIP

Attorney Docket No.: 67,200-1147

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## RESPONSE TO OFFICE ACTION

Assistant Commissioner for Patents P.O. Box 1450 Alexandria, Va 22313-1450

Dear Sir:

In response to an Office Action mailed 09/22/2005 please enter the following amendments and consider the following remarks.